

This diagram shows an exploded perspective view of a multi-layer printed circuit board (PCB) assembly, designated by reference numeral 10. The assembly consists of several stacked layers and components:

- Top Layer (11):** The uppermost layer, featuring a central rectangular opening (14) and a series of rectangular slots (20) along its top edge. A small circular feature (30) is located near the top edge.
- Second Layer (12):** Positioned below the top layer, it contains a series of rectangular slots (22) along its top edge, which align with the slots on the top layer. A small circular feature (32) is also present.
- Third Layer (16):** A layer below the second, showing a series of rectangular slots (18) along its top edge.
- Bottom Layer (46):** The base layer of the assembly, featuring a large rectangular opening (50) and a series of rectangular slots (52) along its bottom edge. A small circular feature (54) is located near the bottom edge.
- Intermediate Layer (26):** A layer between the second and third layers, showing a series of rectangular slots (28) along its top edge.
- Bottom Layer (56):** A layer below the bottom layer, showing a series of rectangular slots (58) along its bottom edge.
- Bottom Layer (48):** The bottommost layer, showing a series of rectangular slots (50) along its bottom edge.

Fig. 1

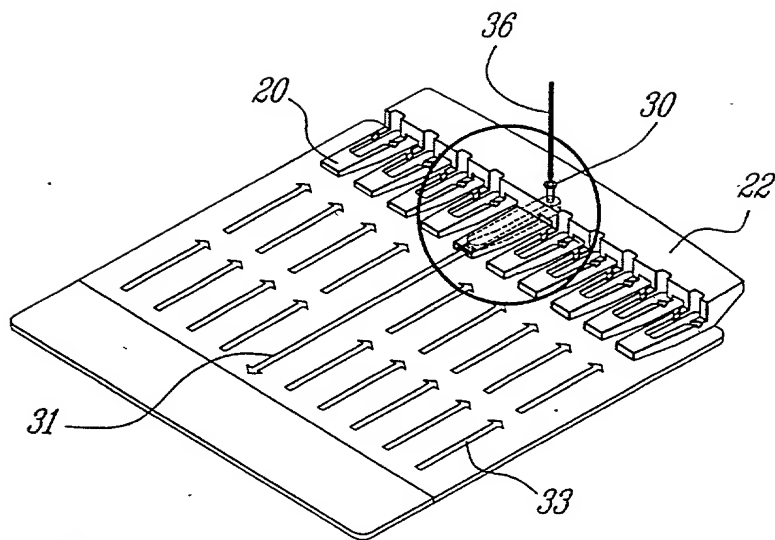


Fig. 2A

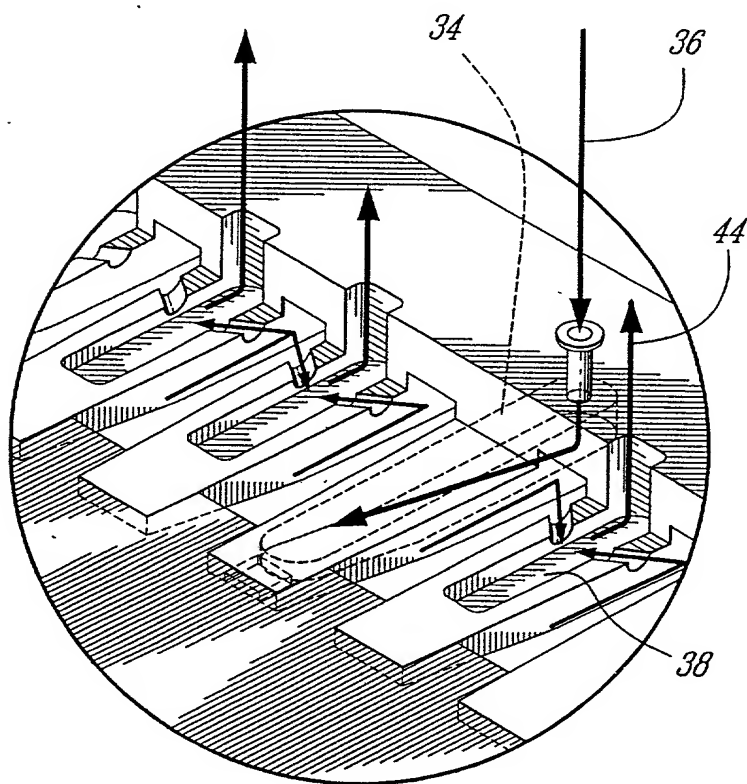
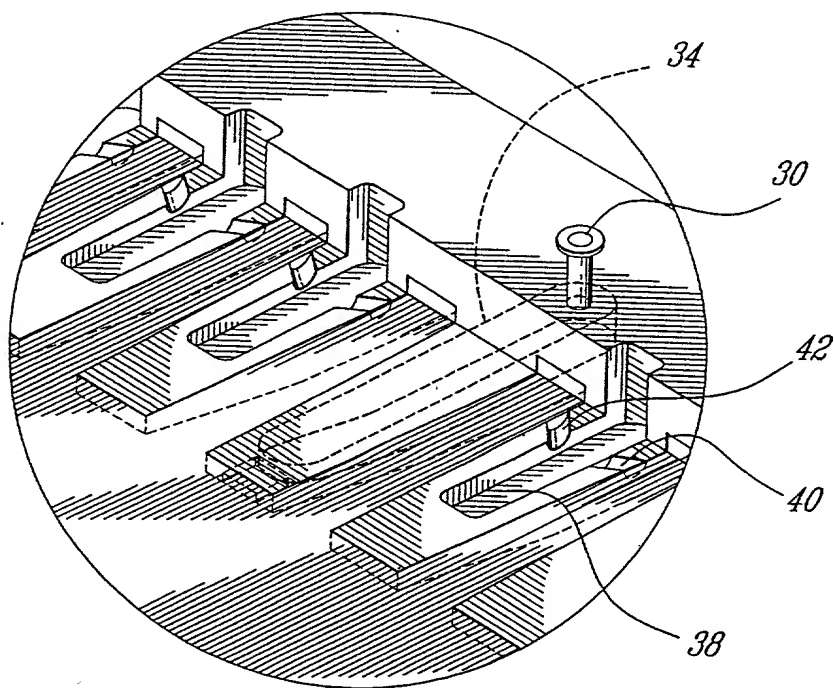
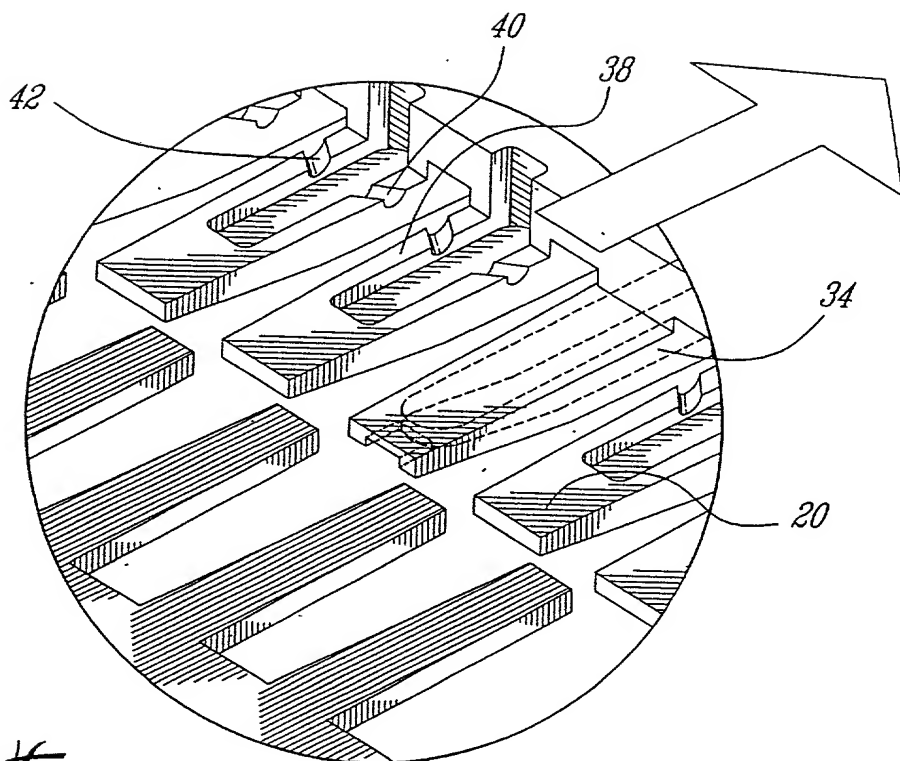


Fig. 2B



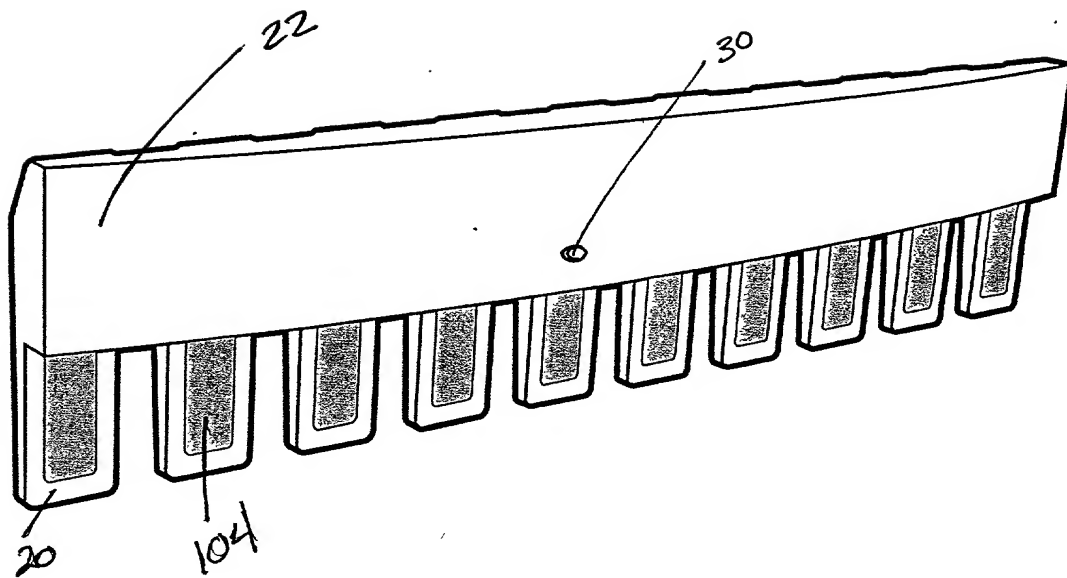
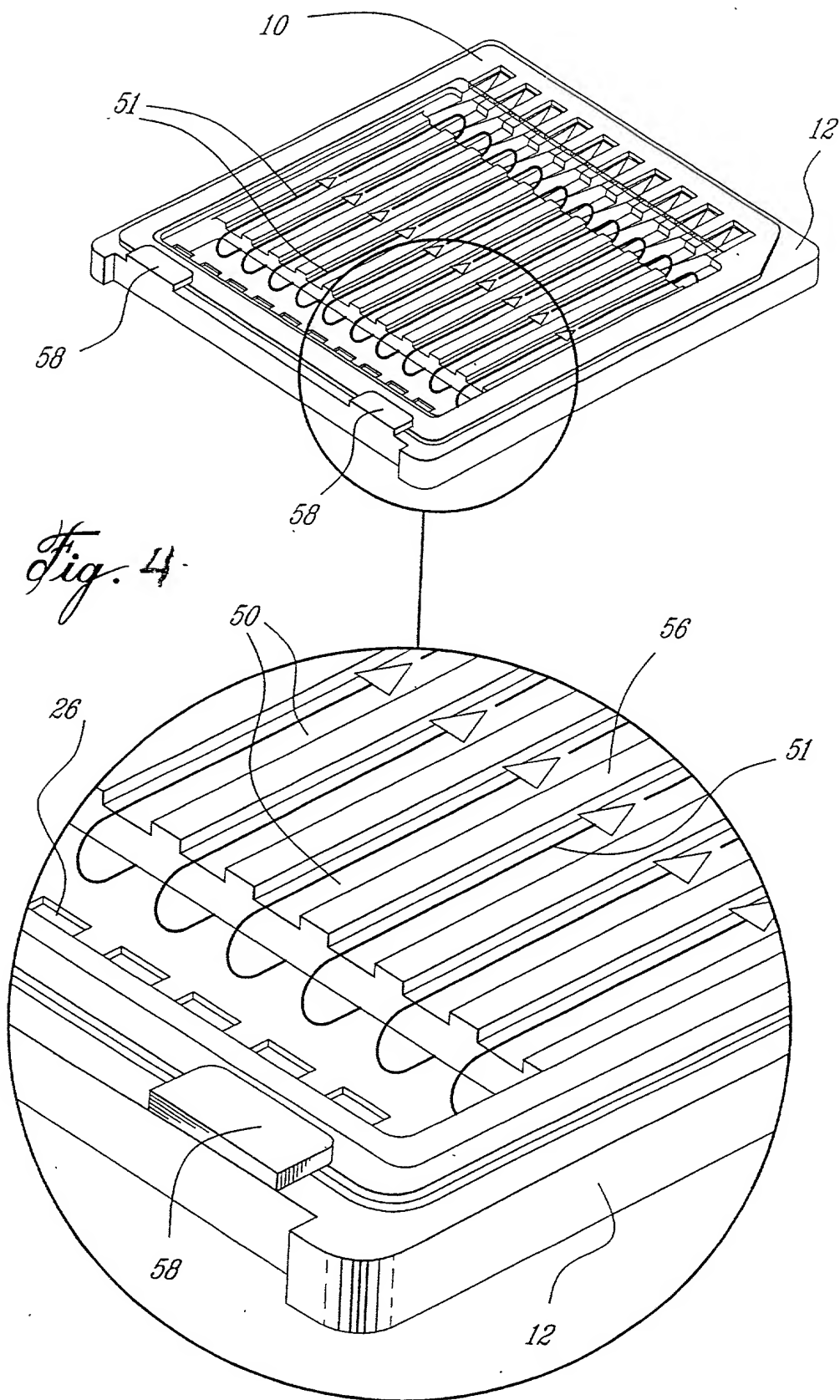
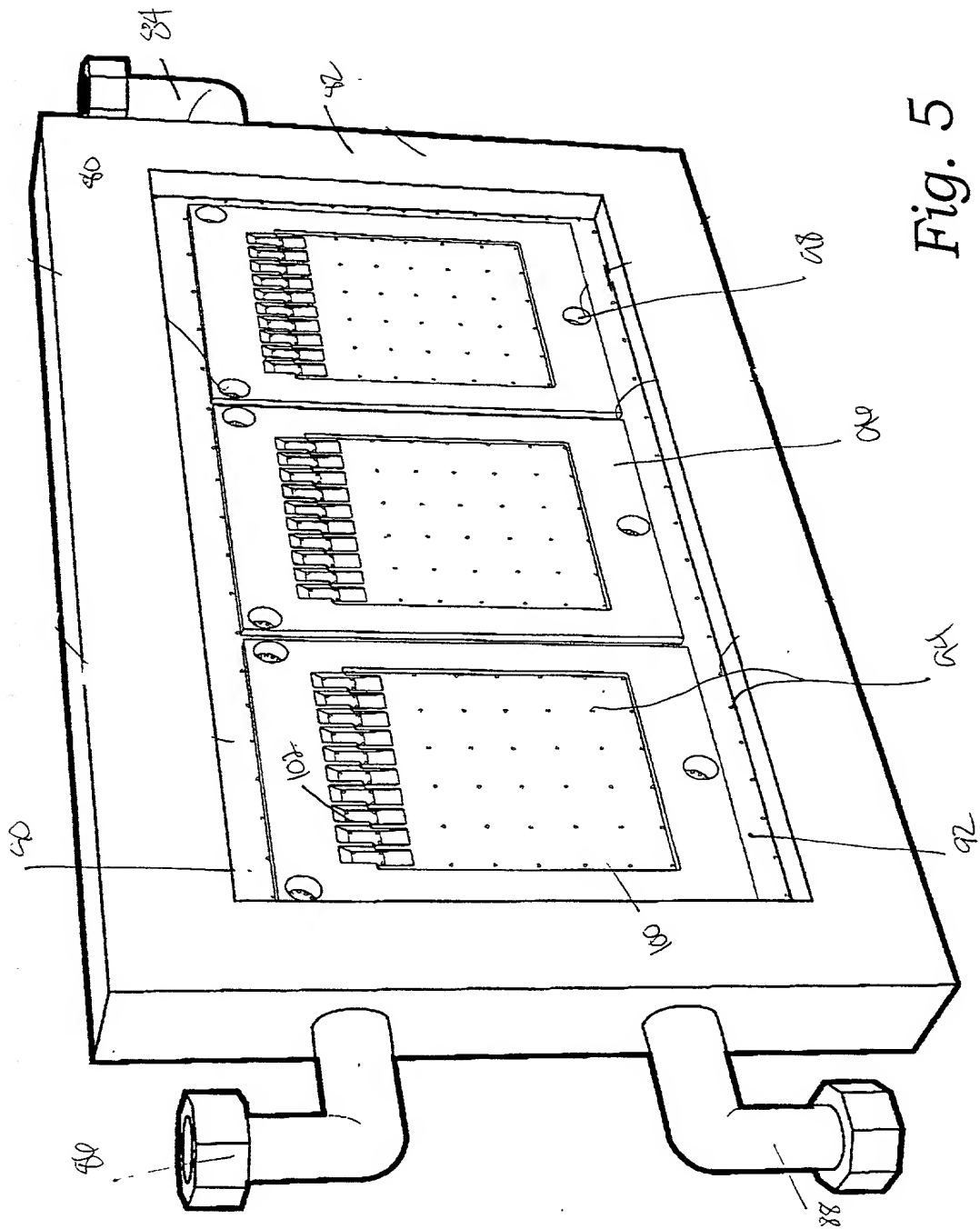


Fig. 3A

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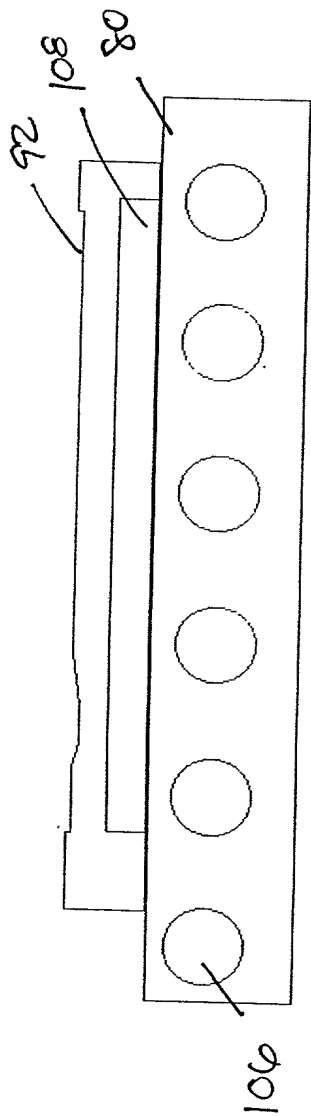


Fig. 6A

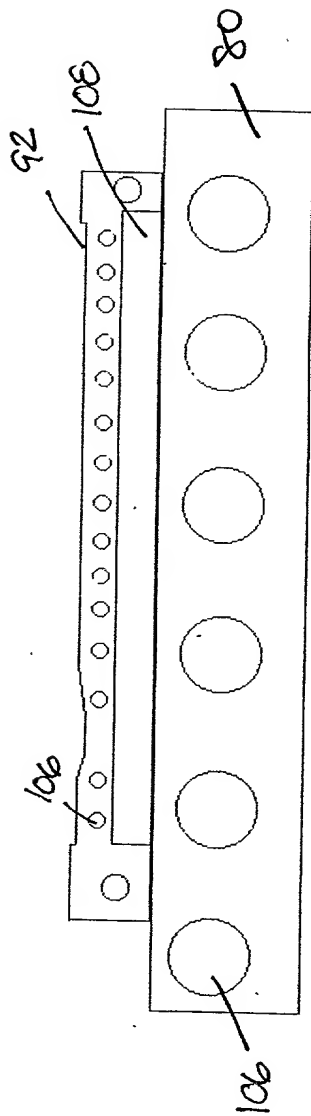


Fig. 6B

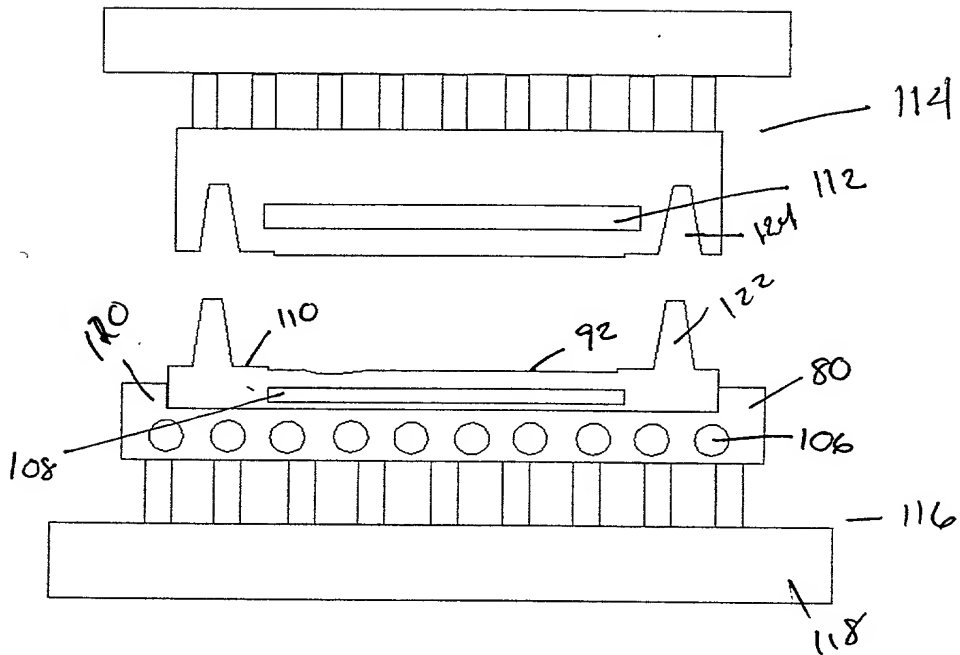


Fig. 7